

# DAC813

## Microprocessor-Compatible 12-BIT DIGITAL-TO-ANALOG CONVERTER

### FEATURES

- $\pm 1/2$ LSB NONLINEARITY OVER TEMPERATURE
- GUARANTEED MONOTONIC OVER TEMPERATURE
- LOW POWER: 270mW typ
- DIGITAL INTERFACE DOUBLE BUFFERED: 12 AND 8 + 4 BITS
- SPECIFIED AT  $\pm 12$ V AND  $\pm 15$ V POWER SUPPLIES
- RESET FUNCTION TO BIPOLAR ZERO
- 0.3" WIDE DIP AND SO PACKAGES

### DESCRIPTION

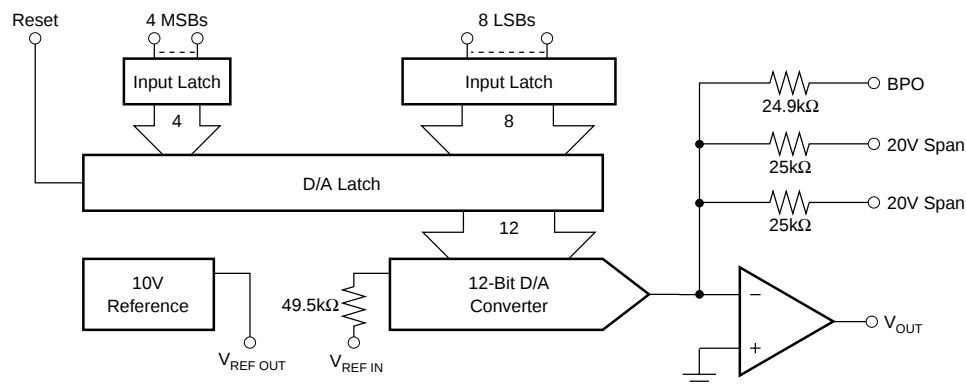
The DAC813 is a complete monolithic 12-bit digital-to-analog converter with a flexible digital interface. It includes a precision +10V reference, interface control logic, double-buffered latch and a 12-bit D/A

converter with voltage output operational amplifier. Fast current switches and laser-trimmed thin-film resistors provide a highly accurate, fast D/A converter.

Digital interfacing is facilitated by a double buffered latch. The input latch consists of one 8-bit byte and one 4-bit nibble to allow interfacing to 8-bit (right justified format) or 16-bit data buses. Input gating logic is designed so that the last nibble or byte to be loaded can be loaded simultaneously with the transfer of data to the D/A latch saving computer instructions.

A reset control allows the DAC813 D/A latch to asynchronously reset the D/A output to bipolar zero, a feature useful for power-up reset, recalibration, or for system re-initialization upon system failure.

The DAC813 is specified to  $\pm 1/2$ LSB maximum linearity error (J, A grades) and  $\pm 1/4$ LSB (K grade). It is packaged in 28-pin 0.3" wide plastic DIP and 28-lead plastic SOIC



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# SPECIFICATIONS

At  $T_A = +25^{\circ}\text{C}$ ,  $\pm V_{CC} = \pm 12\text{V}$  or  $\pm 15\text{V}$  and load on  $V_{OUT} = 5\text{k}\Omega \parallel 500\text{pF}$  to common, unless otherwise noted.

| PARAMETER                                                                                                                                      | CONDITIONS                      | DAC813JP, JU, AU |                    |            | DAC813KP, KU |           |           | UNITS                          |
|------------------------------------------------------------------------------------------------------------------------------------------------|---------------------------------|------------------|--------------------|------------|--------------|-----------|-----------|--------------------------------|
|                                                                                                                                                |                                 | MIN              | TYP                | MAX        | MIN          | TYP       | MAX       |                                |
| <b>DIGITAL INPUTS</b>                                                                                                                          |                                 |                  |                    |            |              |           |           |                                |
| Resolution Codes <sup>(1)</sup>                                                                                                                |                                 |                  | USB, BOB           | 12         |              | *         | *         | Bits                           |
| Digital Inputs Over Temperature Range <sup>(2)</sup>                                                                                           |                                 |                  |                    |            |              |           |           |                                |
| $V_{IH}$ <sup>(3)</sup>                                                                                                                        |                                 | +2               |                    | +5.5       | *            |           | *         | VDC                            |
| $V_{IL}$                                                                                                                                       |                                 | 0                |                    | +0.8       | *            |           | *         | VDC                            |
| DATA Bits, $\overline{\text{WR}}$ , $\overline{\text{Reset}}$ , $\overline{\text{LDAC}}$ , $\overline{\text{LMSB}}$ , $\overline{\text{LLSB}}$ |                                 |                  |                    | $\pm 10$   |              |           | *         | $\mu\text{A}$                  |
| $I_{IH}$                                                                                                                                       | $V_{IN} = +2.7\text{V}$         |                  |                    | $\pm 10$   |              |           | *         | $\mu\text{A}$                  |
| $I_{IL}$                                                                                                                                       | $V_{IN} = +0.4\text{V}$         |                  |                    |            |              |           |           |                                |
| <b>ACCURACY</b>                                                                                                                                |                                 |                  |                    |            |              |           |           |                                |
| Linearity Error                                                                                                                                |                                 |                  | $\pm 1/4$          | $\pm 1/2$  |              | $\pm 1/8$ | $\pm 1/4$ | LSB                            |
| Differential Linearity Error                                                                                                                   |                                 |                  | $\pm 1/2$          | $\pm 3/4$  |              | $\pm 1/4$ | $\pm 1/2$ | LSB                            |
| Gain Error <sup>(4)</sup>                                                                                                                      |                                 |                  | $\pm 0.05$         | $\pm 0.2$  |              | *         | *         | %                              |
| Unipolar Offset Error <sup>(5)</sup>                                                                                                           |                                 |                  | $\pm 0.01$         | $\pm 0.02$ |              | *         | *         | % of FSR <sup>(7)</sup>        |
| Bipolar Zero Error <sup>(6)</sup>                                                                                                              |                                 |                  | $\pm 0.02$         | $\pm 0.2$  |              | *         | *         | % of FSR                       |
| Monotonicity                                                                                                                                   |                                 |                  | Guaranteed         |            |              | *         | *         |                                |
| Power Supply Sensitivity: $+V_{CC}$                                                                                                            | 20V Range                       |                  | 5                  | 10         |              | *         | *         | ppm of FSR/%                   |
| $-V_{CC}$                                                                                                                                      |                                 |                  | 1                  | 10         |              | *         | *         | ppm of FSR/%                   |
| <b>DRIFT</b>                                                                                                                                   |                                 |                  |                    |            |              |           |           |                                |
| Gain                                                                                                                                           | Over Specification              |                  | $\pm 5$            | $\pm 30$   |              | *         | $\pm 15$  | ppm/ $^{\circ}\text{C}$        |
| Unipolar Offset                                                                                                                                | Temperature Range               |                  | $\pm 1$            | $\pm 3$    |              | *         | $\pm 3$   | ppm of FSR/ $^{\circ}\text{C}$ |
| Bipolar Zero                                                                                                                                   |                                 |                  | $\pm 3$            | $\pm 10$   |              | *         | $\pm 5$   | ppm of FSR/ $^{\circ}\text{C}$ |
| Linearity Error Over Temperature Range                                                                                                         |                                 |                  | $\pm 1/2$          | $\pm 3/4$  |              | $\pm 1/4$ | $\pm 1/2$ | LSB                            |
| Monotonicity Over Temperature Range                                                                                                            |                                 |                  | Guaranteed         |            |              | *         |           |                                |
| <b>SETTLING TIME</b> <sup>(8)</sup> (To Within $\pm 0.01\%$ of FSR of Final Value; $5\text{k}\Omega \parallel 500\text{pF}$ load)              |                                 |                  |                    |            |              |           |           |                                |
| For Full Scale Range Change                                                                                                                    | 20V Range                       |                  | 4.5                | 6          |              | *         | *         | $\mu\text{s}$                  |
|                                                                                                                                                | 10V Range                       |                  | 3.3                | 5          |              | *         | *         | $\mu\text{s}$                  |
| For 1LSB Change at Major Carry <sup>(9)</sup>                                                                                                  |                                 |                  | 2                  |            |              | *         |           | $\mu\text{s}$                  |
| Slew Rate                                                                                                                                      |                                 |                  | 10                 |            |              | *         |           | V/ $\mu\text{s}$               |
| <b>ANALOG OUTPUT</b>                                                                                                                           |                                 |                  |                    |            |              |           |           |                                |
| Voltage Range: Unipolar                                                                                                                        | $\pm V_{CC} > \pm 11.4\text{V}$ |                  | 0 to +10           |            |              | *         |           | V                              |
| Bipolar                                                                                                                                        | $\pm V_{CC} > \pm 11.4\text{V}$ |                  | $\pm 5$ , $\pm 10$ |            |              | *         |           | V                              |
| Output Current                                                                                                                                 |                                 | $\pm 5$          |                    |            | *            |           |           | mA                             |
| Output Impedance                                                                                                                               | At DC                           |                  | 0.2                |            |              | *         |           | $\Omega$                       |
| Short Circuit to Common Duration                                                                                                               |                                 |                  | Indefinite         |            |              | *         |           |                                |
| <b>REFERENCE VOLTAGE</b>                                                                                                                       |                                 |                  |                    |            |              |           |           |                                |
| Voltage                                                                                                                                        |                                 | +9.95            | +10                | +10.05     | *            | *         | *         | V                              |
| Source Current Available for External Loads                                                                                                    |                                 | 5                |                    |            | *            |           |           | mA                             |
| Impedance                                                                                                                                      |                                 |                  | 2                  |            |              | *         |           | $\Omega$                       |
| Temperature Coefficient                                                                                                                        |                                 |                  | $\pm 5$            | $\pm 25$   |              | *         | *         | ppm/ $^{\circ}\text{C}$        |
| Short Circuit to Common Duration                                                                                                               |                                 |                  | Indefinite         |            |              | *         |           |                                |
| <b>POWER SUPPLY REQUIREMENTS</b>                                                                                                               |                                 |                  |                    |            |              |           |           |                                |
| Voltage: $+V_{CC}$                                                                                                                             |                                 | +11.4            | +15                | +16.5      | *            | *         | *         | VDC                            |
| $-V_{CC}$                                                                                                                                      |                                 | -11.4            | -15                | -16.5      | *            | *         | *         | VDC                            |
| Current: $+V_{CC} + V_L$                                                                                                                       | No Load                         |                  | 13                 | 15         |              | *         | *         | mA                             |
| $-V_{CC}$                                                                                                                                      | No Load                         |                  | -5                 | -7         |              | *         | *         | mA                             |
| Potential at DCOM with Respect to ACOM <sup>(10)</sup>                                                                                         |                                 | -3               |                    | +3         | *            | *         | *         | V                              |
| Power Dissipation                                                                                                                              |                                 |                  | 270                | 330        |              | *         | *         | mW                             |
| <b>TEMPERATURE RANGE</b>                                                                                                                       |                                 |                  |                    |            |              |           |           |                                |
| Specification: J, K                                                                                                                            |                                 | 0                |                    | +70        | *            |           | *         | $^{\circ}\text{C}$             |
| A                                                                                                                                              |                                 | -40              |                    | +85        | *            |           | *         | $^{\circ}\text{C}$             |
| Operating: J, K                                                                                                                                |                                 | -40              |                    | +85        | *            |           | *         | $^{\circ}\text{C}$             |
| A                                                                                                                                              |                                 | -55              |                    | +125       | *            |           | *         | $^{\circ}\text{C}$             |
| Storage: J, K                                                                                                                                  |                                 | -60              |                    | +100       | *            |           | *         | $^{\circ}\text{C}$             |
| A                                                                                                                                              |                                 | -65              |                    | +150       | *            |           | *         | $^{\circ}\text{C}$             |

\* Same as specification for DAC813AU, JP, JU.

NOTES: (1) USB = Unipolar Straight Binary; BOB = Bipolar Offset Binary. (2) TTL and 5V CMOS compatible. (3) Open DATA input lines will be pulled above +5.5V. See discussion under LOGIC INPUT COMPATIBILITY in the OPERATION section. (4) Specified with  $500\Omega$  Pin 6 to 7. Adjustable to zero with external trim potentiometer. (5) Error at input code  $000_{\text{HEX}}$  for unipolar mode, FSR = 10V. (6) Error at input code  $800_{\text{HEX}}$  for bipolar range. Specified with  $100\Omega$  Pin 6 to 4 and with  $500\Omega$  pin 6 to 7. See page 9 for zero adjustment procedure. (7) FSR means Full Scale Range and is 20V for the  $\pm 10\text{V}$  range. (8) Maximum represents the  $3\sigma$  limit. Not 100% tested for this parameter. (9) At the major carry,  $7FF_{\text{HEX}}$  to  $800_{\text{HEX}}$  and  $800_{\text{HEX}}$  to  $7FF_{\text{HEX}}$ . (10) The maximum voltage at which ACOM and DCOM may be separated without affecting accuracy specifications.

## PIN DESCRIPTIONS

| PIN  | NAME                 | DESCRIPTION                                                                                                                         |
|------|----------------------|-------------------------------------------------------------------------------------------------------------------------------------|
| 1    | +V <sub>L</sub>      | Positive supply pin for logic circuits. Connect to +V <sub>CC</sub> .                                                               |
| 2, 3 | 20V Range            | Connect Pin 2 or Pin 3 to Pin 9 (V <sub>OUT</sub> ) for a 20V FSR. Connect both to Pin 9 for a 10V FSR.                             |
| 4    | BPO                  | Bipolar offset. Connect to Pin 6 (V <sub>REF OUT</sub> ) through 100Ω resistor or 200Ω potentiometer for bipolar operation.         |
| 5    | ACOM                 | Analog common, ±V <sub>CC</sub> supply return.                                                                                      |
| 6    | V <sub>REF OUT</sub> | +10V reference output referred to ACOM.                                                                                             |
| 7    | V <sub>REF IN</sub>  | Connected to V <sub>REF OUT</sub> through a 1kΩ gain adjustment potentiometer or a 500Ω resistor.                                   |
| 8    | +V <sub>CC</sub>     | Analog supply input, nominally +12V to +15V referred to ACOM.                                                                       |
| 9    | V <sub>OUT</sub>     | D/A converter voltage output.                                                                                                       |
| 10   | -V <sub>CC</sub>     | Analog supply input, nominally -12V or -15V referred to ACOM.                                                                       |
| 11   | WR                   | Master enable for LDAC, LLSB, and LMSB. Must be low for data transfer to any latch.                                                 |
| 12   | LDAC                 | Load DAC. Must be low with WR for data transfer to the D/A latch and simultaneous update of the D/A converter.                      |
| 13   | Reset                | When low, resets the D/A latch such that a Bipolar Zero output is produced. This control overrides all other data input operations. |
| 14   | LMSB                 | Enable for 4-bit input latch of D <sub>8</sub> -D <sub>11</sub> data inputs. NOTE: This logic path is slower than the WR path.      |
| 15   | LLSB                 | Enable for 8-bit input latch of D <sub>0</sub> -D <sub>7</sub> data inputs. NOTE: This logic path is slower than the WR path.       |
| 16   | DCOM                 | Digital common.                                                                                                                     |
| 17   | D0                   | Data Bit 1, LSB.                                                                                                                    |
| 18   | D1                   | Data Bit 2.                                                                                                                         |
| 19   | D2                   | Data Bit 3.                                                                                                                         |
| 20   | D3                   | Data Bit 4.                                                                                                                         |
| 21   | D4                   | Data Bit 5.                                                                                                                         |
| 22   | D5                   | Data Bit 6.                                                                                                                         |
| 23   | D6                   | Data Bit 7.                                                                                                                         |
| 24   | D7                   | Data Bit 8.                                                                                                                         |
| 25   | D8                   | Data Bit 9.                                                                                                                         |
| 26   | D9                   | Data Bit 10.                                                                                                                        |
| 27   | D10                  | Data Bit 11.                                                                                                                        |
| 28   | D11                  | Data Bit 12, MSB, positive true.                                                                                                    |

## ABSOLUTE MAXIMUM RATINGS<sup>(1)</sup>

|                                                             |                           |
|-------------------------------------------------------------|---------------------------|
| +V <sub>CC</sub> to ACOM                                    | 0 to +18V                 |
| -V <sub>CC</sub> to ACOM                                    | 0 to -18V                 |
| +V <sub>CC</sub> to -V <sub>CC</sub>                        | 0 to +36V                 |
| DCOM with respect to ACOM                                   | ±4V                       |
| Digital Inputs (Pins 11–15, 17–28) to DCOM                  | -0.5V to +V <sub>CC</sub> |
| External Voltage Applied to BPO Span Resistor               | ±V <sub>CC</sub>          |
| V <sub>REF OUT</sub>                                        | Indefinite Short to ACOM  |
| V <sub>OUT</sub>                                            | Indefinite Short to ACOM  |
| Power Dissipation                                           | 750mW                     |
| Lead Temperature (soldering, 10s)                           | +300°C                    |
| Max Junction Temperature                                    | +165°C                    |
| Thermal Resistance, θ <sub>J-A</sub> : Plastic DIP and SOIC | 130°C/W                   |
| Ceramic DIP                                                 | 85°C/W                    |

NOTE: (1) Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. Exposure to absolute maximum conditions for extended periods may affect device reliability.



## ELECTROSTATIC DISCHARGE SENSITIVITY

Electrostatic discharge can cause damage ranging from performance degradation to complete device failure. Burr-Brown Corporation recommends that all integrated circuits be handled and stored using appropriate ESD protection methods.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet published specifications.

## PACKAGE/ORDERING INFORMATION

| PRODUCT  | PACKAGE              | PACKAGE DRAWING NUMBER <sup>(1)</sup> | TEMPERATURE RANGE | LINEARITY ERROR, MAX AT +25°C (LSB) | GAIN DRIFT (ppm/°C) |
|----------|----------------------|---------------------------------------|-------------------|-------------------------------------|---------------------|
| DAC813JP | 28-Pin Plastic DIP   | 246                                   | 0°C to +70°C      | ±1/2                                | ±30                 |
| DAC813JU | 28-Lead Plastic SOIC | 217                                   | 0°C to +70°C      | ±1/2                                | ±30                 |
| DAC813KP | 28-Pin Plastic DIP   | 246                                   | 0°C to +70°C      | ±1/4                                | ±15                 |
| DAC813KU | 28-Lead Plastic SOIC | 217                                   | 0°C to +70°C      | ±1/4                                | ±15                 |
| DAC813AU | 28-Lead Plastic SOIC | 217                                   | -40°C to +85°C    | ±1/2                                | ±30                 |

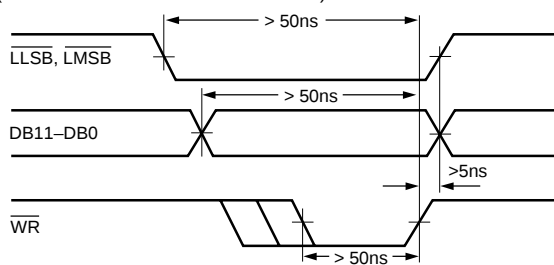
NOTE: (1) For detailed drawing and dimension table, please see end of data sheet, or Appendix C of Burr-Brown IC Data Book.

The information provided herein is believed to be reliable; however, BURR-BROWN assumes no responsibility for inaccuracies or omissions. BURR-BROWN assumes no responsibility for the use of this information, and all use of such information shall be entirely at the user's own risk. Prices and specifications are subject to change without notice. No patent rights or licenses to any of the circuits described herein are implied or granted to any third party. BURR-BROWN does not authorize or warrant any BURR-BROWN product for use in life support devices and/or systems.

## MINIMUM TIMING DIAGRAMS

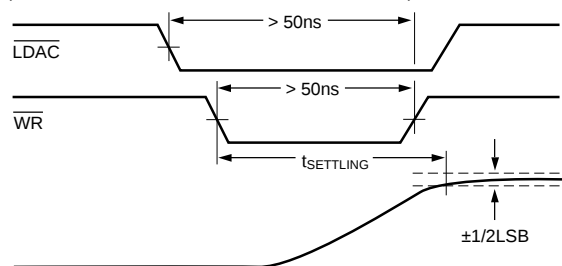
### WRITE CYCLE #1

(Load first rank from Data Bus:  $\overline{\text{LDAC}} = 1$ )



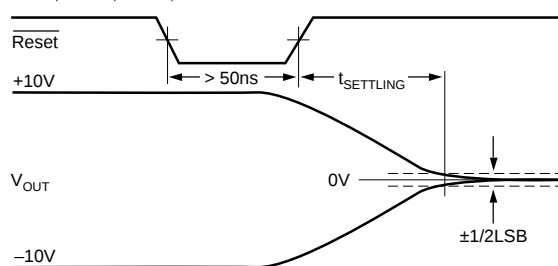
### WRITE CYCLE #2

(Load second rank from first rank:  $\overline{\text{LLSB}}$ ,  $\overline{\text{LMSB}} = 1$ )



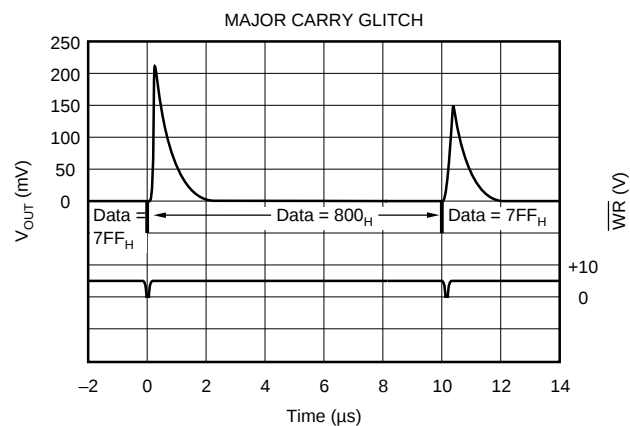
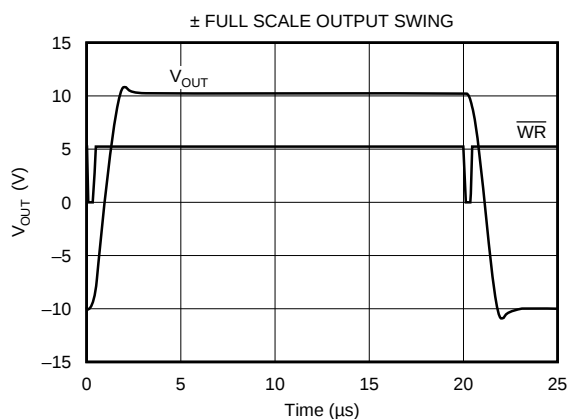
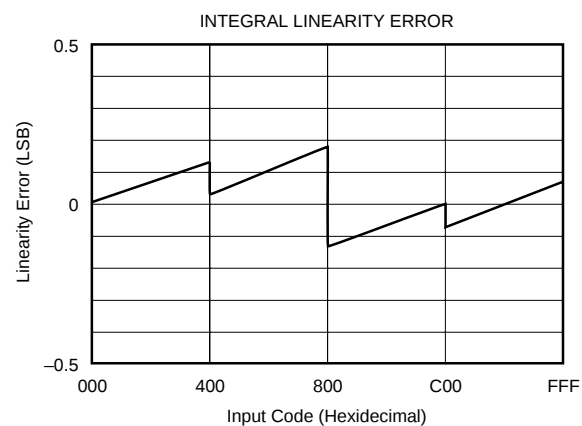
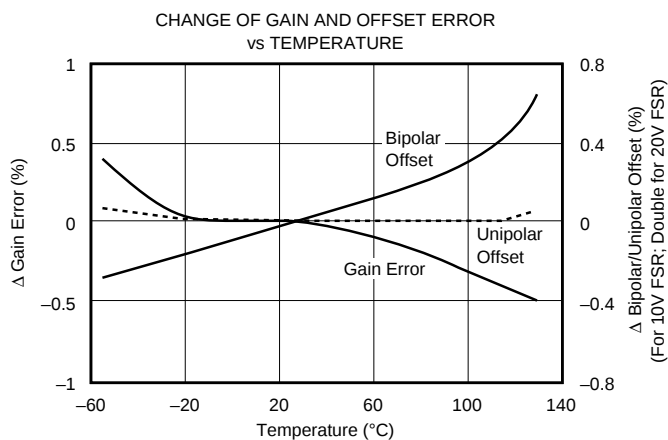
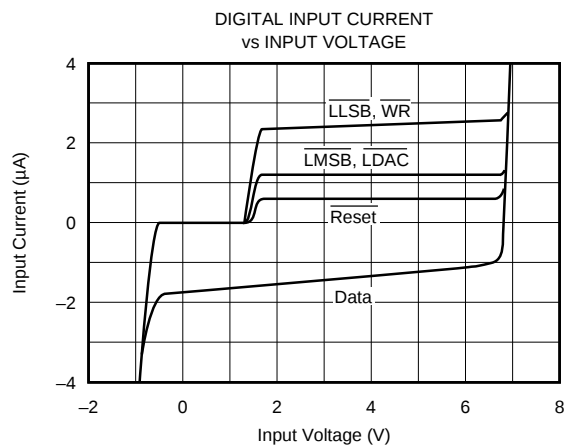
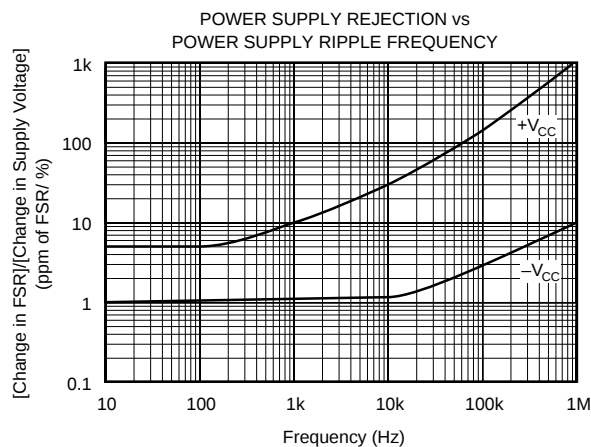
### RESET COMMAND (Bipolar Mode)

$\overline{\text{LLSB}}$ ,  $\overline{\text{LMSB}}$ ,  $\overline{\text{LDAC}}$ ,  $\overline{\text{WR}}$  = Don't Care



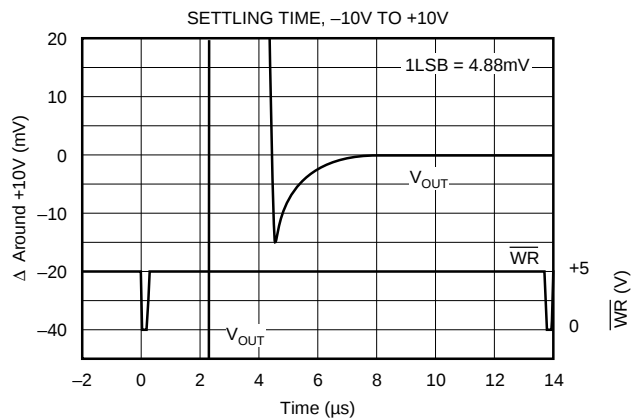
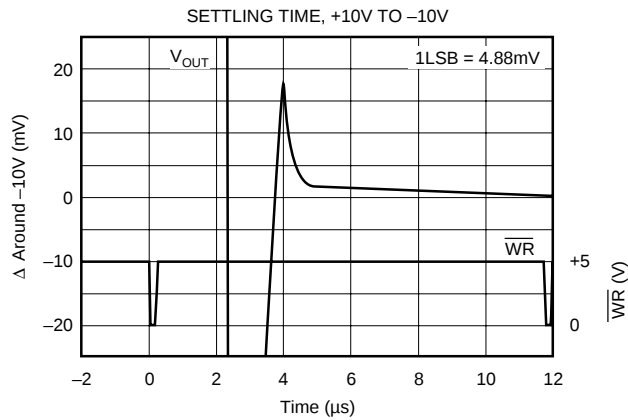
# TYPICAL PERFORMANCE CURVES

At  $T_A = +25^\circ\text{C}$ ,  $V_{CC} = \pm 15\text{V}$ , unless otherwise noted.



## TYPICAL PERFORMANCE CURVES (CONT)

At  $T_A = +25^\circ\text{C}$ ,  $V_{CC} = \pm 15\text{V}$ , unless otherwise noted.



## DISCUSSION OF SPECIFICATIONS

### INPUT CODES

The DAC813 accepts positive-true binary input codes. DAC813 may be connected by the user for any one of the following codes: USB (Unipolar Straight Binary), BOB (Bipolar Offset Binary) or, using an external inverter on the MSB line, BTC (Binary Two's Complement). See Table I.

| DIGITAL INPUT      | ANALOG OUTPUT                         |                                    |                                       |
|--------------------|---------------------------------------|------------------------------------|---------------------------------------|
|                    | USB<br>Unipolar<br>Straight<br>Binary | BOB<br>Bipolar<br>Offset<br>Binary | BTC*<br>Binary<br>Two's<br>Complement |
| MSB to LSB         |                                       |                                    |                                       |
| FFF <sub>HEX</sub> | + Full Scale                          | + Full Scale                       | Zero - 1LSB                           |
| 800 <sub>HEX</sub> | + 1/2 Full Scale                      | Zero                               | - Full Scale                          |
| 7FF <sub>HEX</sub> | + 1/2 Full Scale - 1LSB               | Zero - 1LSB                        | + Full Scale                          |
| 000 <sub>HEX</sub> | Zero                                  | - Full Scale                       | Zero                                  |

\* Invert MSB of BOB code with external inverter to obtain BTC code.

TABLE I. Digital Input Codes.

### LINEARITY ERROR

Linearity error as used in D/A converter specifications by Burr-Brown is the deviation of the analog output from a straight line drawn between the end points (inputs all "1s" and all "0s"). The DAC813 linearity error is specified at  $\pm 1/4\text{LSB}$  (max) at  $+25^\circ\text{C}$  K grades, and  $\pm 1/2\text{LSB}$  (max) for J grades.

### DIFFERENTIAL LINEARITY ERROR

Differential linearity error (DLE) is the deviation from a 1LSB output change from one adjacent state to the next. A DLE specification of  $1/2\text{LSB}$  means that the output step size can range from  $1/2\text{LSB}$  to  $3/2\text{LSB}$  when the input changes from one state to the next. Monotonicity requires that DLE be less than 1LSB over the temperature range of interest.

### MONOTONICITY

A D/A converter is monotonic if the output either increases or remains the same for increasing digital inputs. All grades of DAC813 are monotonic over their specification temperature range.

### DRIFT

Gain Drift is a measure of the change in the Full Scale Range (FSR) output over the specification temperature range. Gain Drift is expressed in parts per million per degree Celsius (ppm/ $^\circ\text{C}$ ).

Unipolar Offset Drift is measured with a data input of 000<sub>HEX</sub>. The D/A is configured for unipolar output. Unipolar Offset Drift is expressed in parts per million of Full Scale Range per degree Celsius (ppm of FSR/ $^\circ\text{C}$ ).

Bipolar Zero Drift is measured with a data input of 800<sub>HEX</sub>. The D/A is configured for bipolar output. Bipolar Zero Drift is expressed in parts per million of Full Scale Range per degree Celsius (ppm of FSR/ $^\circ\text{C}$ ).

### SETTLING TIME

Settling Time is the total time (including slew time) for the output to settle within an error band around its final value after a change in input. Three settling times are specified to  $\pm 0.012\%$  of Full Scale Range (FSR): two for maximum full scale range changes of 20V and 10V, and one for a 1LSB change. The 1LSB change is measured at the major carry (7FF<sub>HEX</sub> to 800<sub>HEX</sub> and 800<sub>HEX</sub> to 7FF<sub>HEX</sub>), the input transition at which worst-case settling time occurs.

### REFERENCE SUPPLY

DAC813 contains an on-chip +10V reference. This voltage (pin 6) has a tolerance of  $\pm 50\text{mV}$ .  $V_{\text{REF OUT}}$  must be connected to  $V_{\text{REF IN}}$  through a gain adjust resistor with a nominal value of  $500\Omega$ . The connection can be made through an optional  $1\text{k}\Omega$  trim resistor to provide adjustment to zero.



DAC813



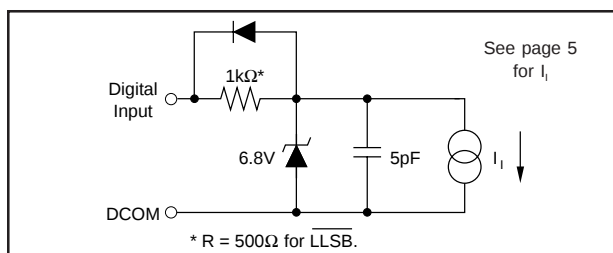


FIGURE 2. Equivalent Input Circuit for Digital Inputs.

the speed of the interface will be slower. A digital output driving a DATA input line of the DAC813 must not drive, **or let the DATA input float**, above +5.5V. Unused DATA inputs should be connected to DCOM.

## RESET FUNCTION

When asserted low ( $<0.8V$ ),  $\overline{RESET}$  (Pin 13) forces the D/A latch to 800<sub>HEX</sub> regardless of any other input logic condition. If the analog output is connected for bipolar operation (either  $\pm 10V$  or  $\pm 5V$ ), the output will be reset to Bipolar Zero (0V). If the analog output is connected for unipolar operation (0 to +10V), the output will be reset to half-scale (+5V).

If  $\overline{RESET}$  is not used, it should be connected to a voltage greater than +2V but not greater than +5.5V. If this voltage is not available Reset can be connected to  $+V_{CC}$  through a 100kΩ to 1MΩ resistor to limit the input current.

## GAIN AND OFFSET ADJUSTMENTS

Figures 3 and 4 illustrate the relationship of offset and gain adjustments to unipolar and bipolar D/A converter output.

### OFFSET ADJUSTMENT

For unipolar (USB) configurations, apply the digital input code that should produce zero voltage output and adjust the offset potentiometer for zero output. For bipolar (BOB,

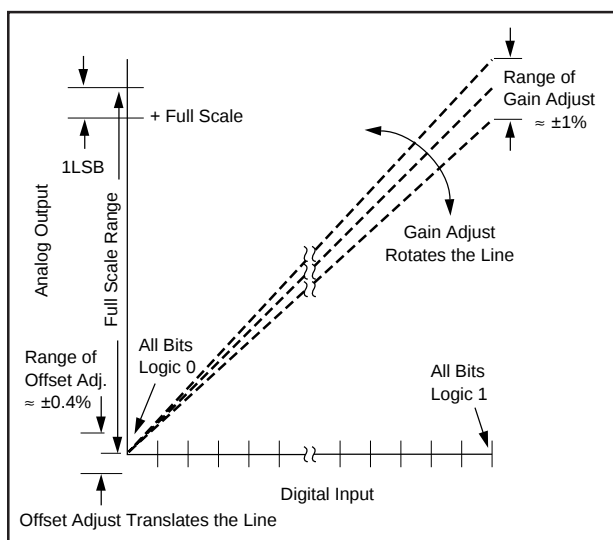


FIGURE 3. Relationship of Offset and Gain Adjustments for a Unipolar D/A Converter.

BTC) configurations, apply the digital input code that should produce the maximum negative output voltage and adjust the offset potentiometer for minus full scale voltage. Example: If the full scale range is connected for 20V, the maximum negative output voltage is  $-10V$ . See Table III for corresponding codes.

## GAIN ADJUSTMENT

For either unipolar or bipolar configurations, apply the digital input that should give the maximum positive voltage output. Adjust the gain potentiometer for this positive full scale voltage. See Table III for positive full scale voltages.

| DIGITAL INPUT<br>MSB to LSB | ANALOG OUTPUT |          |           |
|-----------------------------|---------------|----------|-----------|
|                             | 0 to +10V     | $\pm 5V$ | $\pm 10V$ |
| FFF <sub>HEX</sub>          | +9.9976V      | +4.9976V | +9.9951V  |
| 800 <sub>HEX</sub>          | +5.0000V      | 0.0000V  | 0.0000V   |
| 7FF <sub>HEX</sub>          | +4.9976V      | -0.0024V | -0.0049V  |
| 000 <sub>HEX</sub>          | 0.0000V       | -5.0000V | -10.0000V |
| 1LSB                        | 2.44mV        | 2.44mV   | 4.88mV    |

TABLE III. Digital Input/Analog Output.

## INSTALLATION

### POWER SUPPLY CONNECTIONS

Note that the lid of the ceramic packaged DAC813 is connected to  $-V_{CC}$ . Take care to avoid accidental short circuits in tightly spaced installations.

Power supply decoupling capacitors should be added as shown in Figure 5. Optimum settling performance occurs using a 1 to 10μF tantalum capacitor at  $-V_{CC}$  and at least a 0.01μF ceramic capacitor at  $+V_{CC}$ . Applications with less critical settling time may be able to use 0.01μF at  $-V_{CC}$  as well. The 0.01μF capacitors should be located close to the DAC813.

Pin 1 supplies internal logic and **must** be connected to  $+V_{CC}$ .

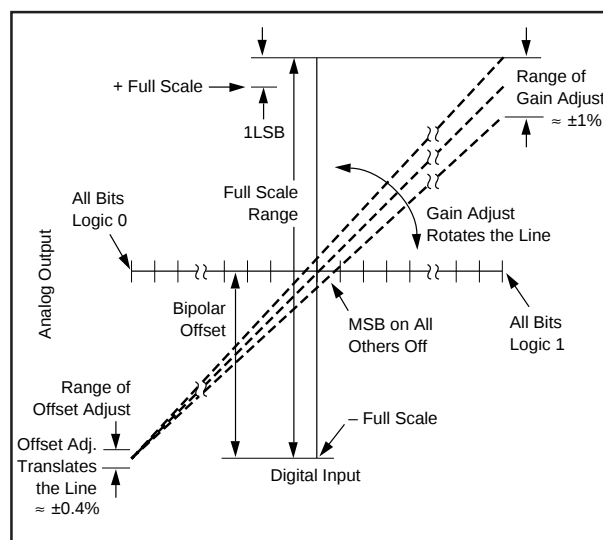


FIGURE 4. Relationship of Offset and Gain Adjustments for a Bipolar D/A Converter.

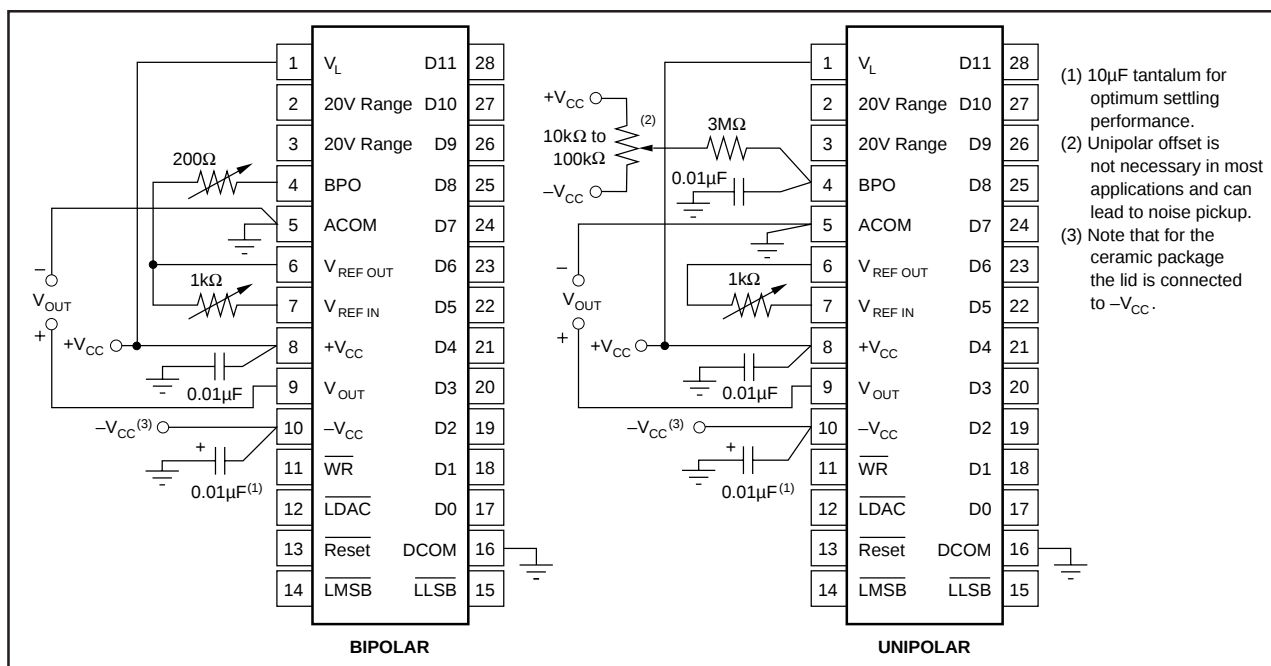


FIGURE 5. Power Supply, Gain, and Offset Connections.

DAC813 features separate digital and analog power supply returns to permit optimum connections for low noise and high speed performance. It is recommended that both Analog Common (ACOM, Pin 5) and Digital Common (DCOM, Pin 16) be connected directly to a ground plane under the package. If a ground plane is not used, connect the ACOM and DCOM pins together close to the package. Since the reference point for  $V_{OUT}$  and  $V_{REF OUT}$  is the ACOM pin, it is also important to connect the load directly to the ACOM pin. Refer to Figure 5.

The change in current in the Analog Common pin (ACOM, Pin 5) due to an input data word change from 000<sub>HEX</sub> to FFF<sub>HEX</sub> is only 800μA.

## OUTPUT RANGE CONNECTIONS

Internal scaling resistors provided in the DAC813 may be connected to produce bipolar output voltage ranges of  $\pm 10V$  and  $\pm 5V$  or unipolar output voltage range of 0 to  $+10V$ . Refer to Figure 6.

The internal feedback resistors (25kΩ) and the bipolar offset resistor (24.9kΩ) are trimmed to an absolute tolerance of less than  $\pm 2\%$ . Therefore, one can change the range by adding a series resistor in various feedback circuit configurations. For example, a 600Ω resistor in series with the 20V range terminal can be used to obtain a 20.48V ( $\pm 10.24V$ ) range (5mV LSB). A 7.98kΩ resistor in series with the 10V range connection (20V ranges in parallel) gives a 16.384V ( $\pm 8.192V$ ) bipolar range (4mV LSB). Gain drift will be affected by the mismatch of the temperature coefficient of the external resistor with the internal D/A resistors.

## APPLICATIONS

### MICROCOMPUTER BUS INTERFACING

The DAC813 interface logic allows easy interface to microcomputer bus structures. The control signal is derived from external device select logic and the I/O Write or Memory Write (depending upon the system design) signals from the microcomputer.

The latch enable lines  $\overline{LMSB}$ ,  $\overline{LLSB}$ , and  $\overline{LDAC}$  determine which of the latches are selected. It is permissible to enable two or more latches simultaneously, as shown in some of the following examples.

The double-buffered latch permits data to be loaded into the input latches of several DAC813s and later strobed into the D/A latch of all D/As, simultaneously updating all analog outputs. All the interface schemes shown below use a base address decoder. If blocks of memory are used, the base address decoder can be simplified or eliminated altogether.

### 8-BIT INTERFACE

The control logic of DAC813 permits interfacing to right-justified data formats, illustrated in Figure 7. When a 12-bit D/A converter is loaded from an 8-bit bus, two bytes of data are required. Figure 8 illustrates an addressing scheme for right-justified data. The base address is decoded from the high-order address bits. A0 and A1 address the appropriate latches. Note that adjacent addresses are used. X10<sub>HEX</sub> loads the 8 LSBs and X01<sub>HEX</sub> loads the 4 MSBs and simultaneously transfers input latch data to the D/A latch. Addresses X00<sub>HEX</sub> and X11<sub>HEX</sub> are not used.

## INTERFACING MULTIPLE DAC813s IN 8-BIT SYSTEMS

Many applications, such as automatic test systems, require that the outputs of several D/A converters be updated simultaneously. The interface shown in Figure 9 uses a 74LSB138 decoder to decode a set of eight adjacent addresses to load the input latches of four DAC813s. The example uses a right-justified data format.

A ninth address using A3 causes all DAC813s to be updated simultaneously. If a certain DAC813 is always loaded last (for instance, D/A #4), A3 is not needed, saving 8 address

spaces for other uses. Incorporate A3 into the base address decoder, remove the inverter, connect the common  $\overline{\text{LDAC}}$  line to  $\overline{\text{LLSB}}$  of D/A #4, and connect D1 of the 74LS138 to +5V.

## 12- AND 16-BIT MICROCOMPUTER INTERFACE

For this application the input latch enable lines,  $\overline{\text{LMSB}}$  and  $\overline{\text{LLSB}}$ , are tied low, causing the latches to be transparent. The D/A latch, and therefore DAC813, is selected by the address decoder and strobed by  $\overline{\text{WR}}$ .

Be sure and read the CAUTION statement in the LOGIC INPUT COMPATIBILITY section.

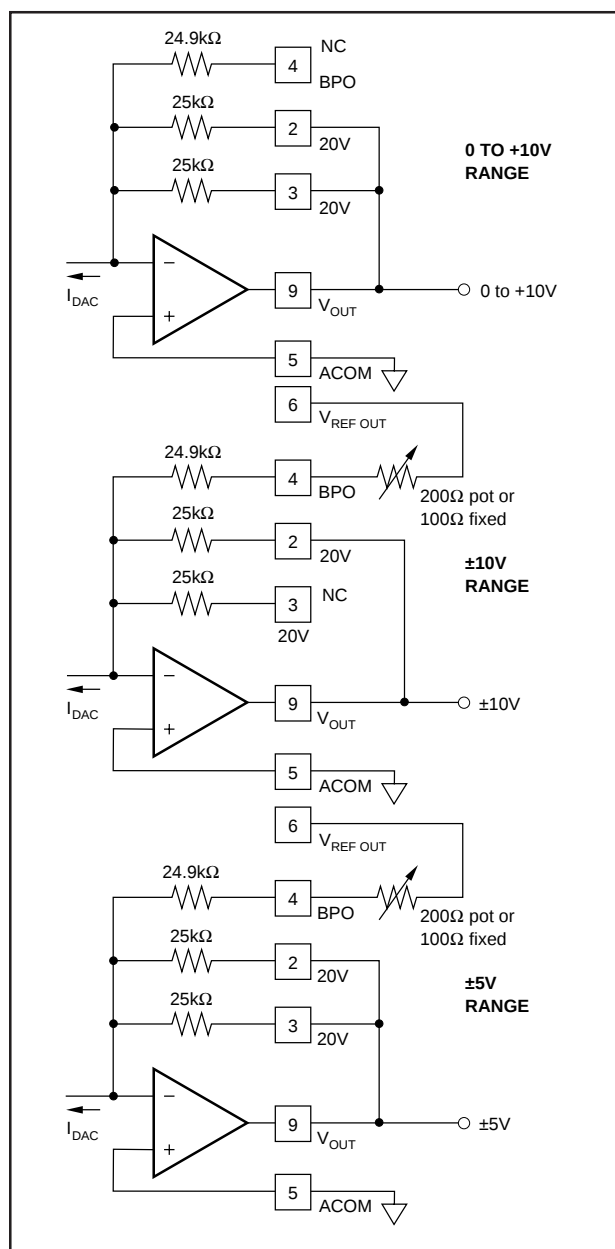


FIGURE 6. Output Amplifier Voltage Range Scaling Circuit.

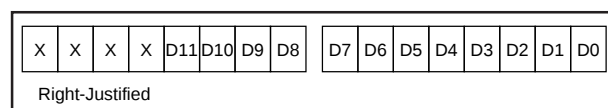


FIGURE 7. 12-Bit Data Format for 8-Bit Systems.

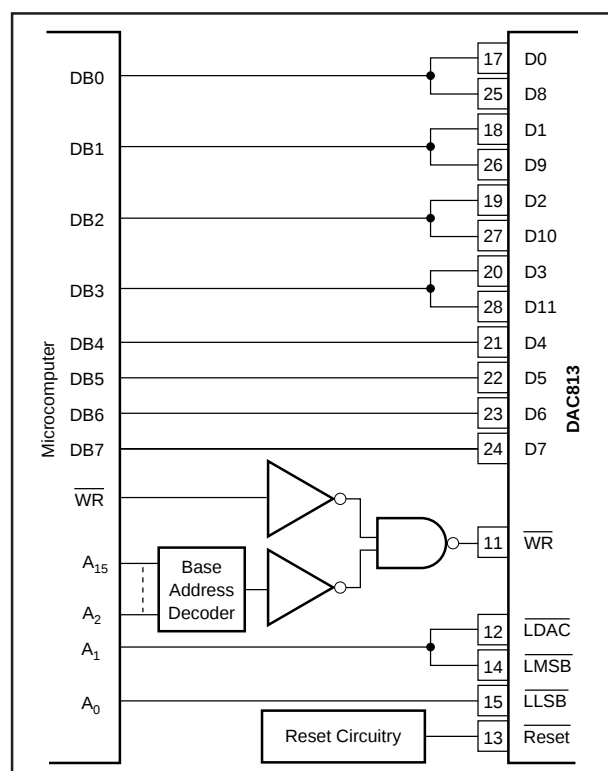
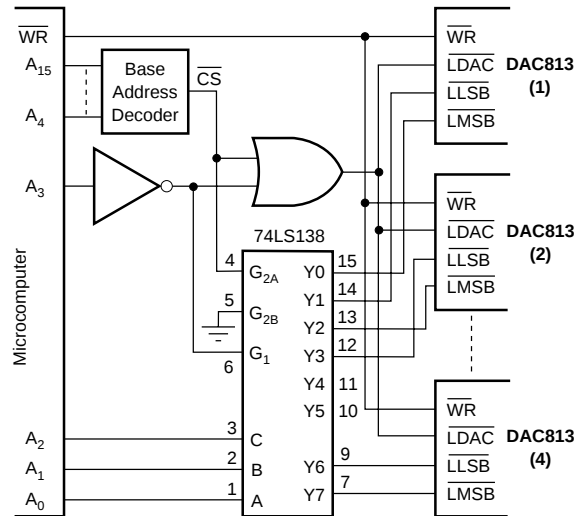


FIGURE 8. Right-Justified Data Bus Interface.



| ADDRESS BUS |    |    |    | OPERATION              |
|-------------|----|----|----|------------------------|
| A3          | A2 | A1 | A0 |                        |
| 0           | 0  | 0  | 0  | Load 8 LSB – D/A #1    |
| 0           | 0  | 0  | 1  | Load 4 MSB – D/A #1    |
| 0           | 0  | 1  | 0  | Load 8 LSB – D/A #2    |
| 0           | 0  | 1  | 1  | Load 4 MSB – D/A #2    |
| 0           | 1  | 0  | 0  | Load 8 LSB – D/A #3    |
| 0           | 1  | 0  | 1  | Load 4 MSB – D/A #3    |
| 0           | 1  | 1  | 0  | Load 8 LSB – D/A #4    |
| 0           | 1  | 1  | 1  | Load 4 MSB – D/A #4    |
| 1           | X  | X  | X  | Load D/A Latch—All D/A |

FIGURE 9. Interfacing Multiple DAC813s to an 8-Bit Bus.

## PACKAGING INFORMATION

| Orderable Device | Status<br>(1) | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan<br>(2)            | Lead/Ball Finish<br>(6) | MSL Peak Temp<br>(3) | Op Temp (°C) | Device Marking<br>(4/5) | Samples                 |
|------------------|---------------|--------------|--------------------|------|----------------|----------------------------|-------------------------|----------------------|--------------|-------------------------|-------------------------|
| DAC813AU         | ACTIVE        | SOIC         | DW                 | 28   | 20             | Green (RoHS<br>& no Sb/Br) | NIPDAU                  | Level-3-260C-168 HR  | -40 to 85    | DAC813AU                | <a href="#">Samples</a> |
| DAC813AU/1K      | ACTIVE        | SOIC         | DW                 | 28   | 1000           | Green (RoHS<br>& no Sb/Br) | NIPDAU                  | Level-3-260C-168 HR  | -40 to 85    | DAC813AU                | <a href="#">Samples</a> |
| DAC813AUG4       | ACTIVE        | SOIC         | DW                 | 28   | 20             | Green (RoHS<br>& no Sb/Br) | NIPDAU                  | Level-3-260C-168 HR  | -40 to 85    | DAC813AU                | <a href="#">Samples</a> |
| DAC813JU         | ACTIVE        | SOIC         | DW                 | 28   | 20             | Green (RoHS<br>& no Sb/Br) | NIPDAU                  | Level-3-260C-168 HR  | 0 to 70      | DAC813JU                | <a href="#">Samples</a> |
| DAC813JU/1K      | ACTIVE        | SOIC         | DW                 | 28   | 1000           | Green (RoHS<br>& no Sb/Br) | NIPDAU                  | Level-3-260C-168 HR  | 0 to 70      | DAC813JU                | <a href="#">Samples</a> |
| DAC813KU         | ACTIVE        | SOIC         | DW                 | 28   | 20             | Green (RoHS<br>& no Sb/Br) | NIPDAU                  | Level-3-260C-168 HR  | 0 to 70      | DAC813KU                | <a href="#">Samples</a> |

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

**RoHS Exempt:** TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

**Green:** TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

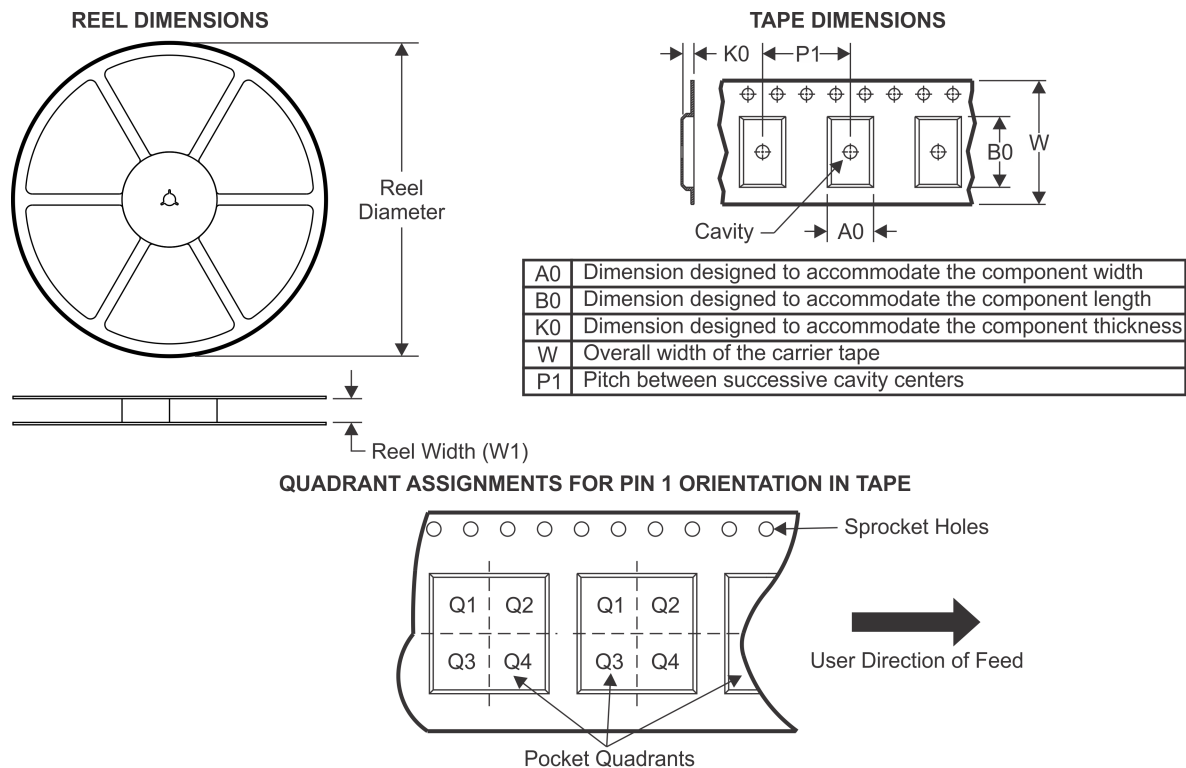
(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "-" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

<sup>(6)</sup> Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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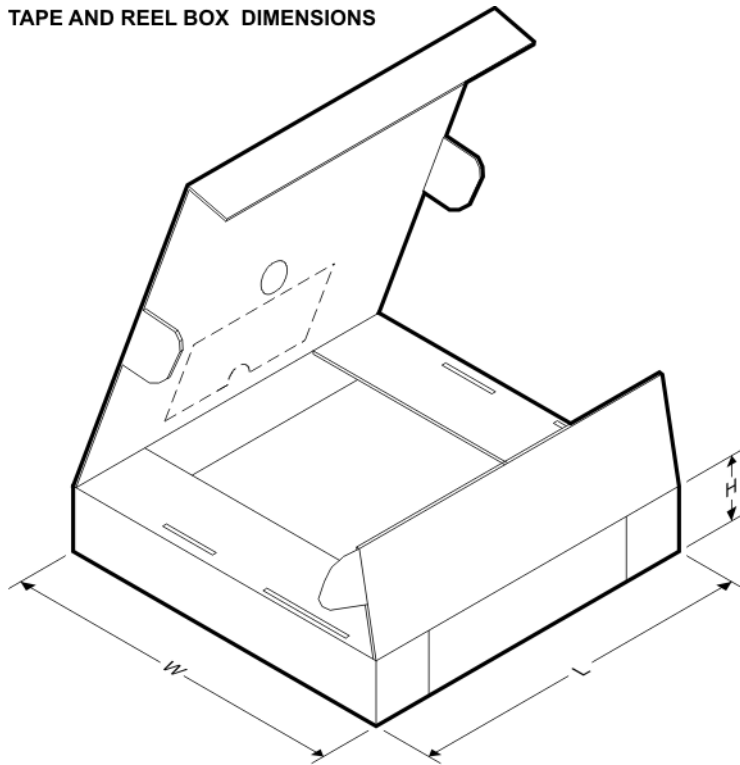
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\*All dimensions are nominal

| Device      | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|-------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| DAC813AU/1K | SOIC         | DW              | 28   | 1000 | 330.0              | 32.4               | 11.35   | 18.67   | 3.1     | 16.0    | 32.0   | Q1            |
| DAC813JU/1K | SOIC         | DW              | 28   | 1000 | 330.0              | 32.4               | 11.35   | 18.67   | 3.1     | 16.0    | 32.0   | Q1            |

## TAPE AND REEL BOX DIMENSIONS



\*All dimensions are nominal

| Device      | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|-------------|--------------|-----------------|------|------|-------------|------------|-------------|
| DAC813AU/1K | SOIC         | DW              | 28   | 1000 | 350.0       | 350.0      | 66.0        |
| DAC813JU/1K | SOIC         | DW              | 28   | 1000 | 350.0       | 350.0      | 66.0        |

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